

# THERMAL POSITIVE PLATE DEVELOPER GSP 85

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## TECHNICAL SPECIFICATIONS

Description	Minimum aggression of the coating in the image areas obtaining the maximum cleaning of the non images areas. Maintaining in the bath the correct conductivity values. High emulsion dissolving properties to minimize the accumulation of residuals in the automatic processor. Long life in processor. Highly recommended for <b>Durable Thermal Positive Plate DTP150</b> , <b>Durable Thermal Positive Plate DTP150i</b> , <b>Durable Thermal Positive Plate DTP150eu</b> and <b>Durable Thermal Positive Plate DTP150i+</b>
Application	Development in processors for thermal plates. Direction for use
Specifications	pH value above 13 and Conductivity between 84 to 86 mS at 25°C
Working temperature	23°C ± 1°C
Developer time	30 ± 5 seconds in immersion
Replenishment	Use Thermal Positive Plate Replenisher GSP100
Replenishment rate	80 ÷ 90 ml/m <sup>2</sup>
Antioxidant Stand by ON	50 ml/h
Antioxidant Stand by OFF	50 ml/h
Considerations	Adequate replenishment keeps filters and circulation systems clean prolonging the life of the bath. Correct cleaning of the equipment will avoid contamination of the new bath and prolong the life of the processor.
Safelight	None required - daylight handling
Shelf life	12 months under recommended storage conditions
Packaging	10, 20 liters
Transport and storage	Should be stored flat and away from excessive cold, heat and humidity. Use in a controlled environment of 5°C – 30°C and 40 – 80% RH, non-condensing
Availability	Contact your local MyLan Group representative. See the list of our Distributors at <a href="http://www.mylangroup.com">www.mylangroup.com</a> for contact information.

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